Form 1449 (Modified) **Information Disclosure Statement By Applicant** (Use Several Sheets if Necessary)	Atty Docket No. NOVLP075/NVLS-000820 Applicant: Tipton et al. Filing Date HEREWITH	Application No.: Unassigned /06723 11 Group Unassigned

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U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
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	A3	6,365,266	4/2/02	MacDougall et al.	428	304.4	
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Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation Yes	No
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Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
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